### **Panasonic**

# **DE2S068**

### Silicon epitaxial planar type

#### For ESD protection

#### Features

- High electrostatic discharge ESD
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

#### Packaging

Embossed type (Thermo-compression sealing): 10000 pcs / reel (standard)

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Total power dissipation <sup>*1</sup>	P <sub>T</sub>	150	mW
Electrostatic discharge *2	ESD	±30	kV
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

Note) \*1:  $P_T = 150 \text{ mW}$  achieved with a printed circuit board.

\*2: Test method: IEC61000-4-2 (C = 150 pF, R = 330  $\Omega$ , Contact discharge: 10 times)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Zener voltage *1,2	Vz	$I_R = 1 \text{ mA}$	6.46		7.14	V
Reverse current	I <sub>R</sub>	$V_R = 4 V$			0.5	μΑ
Terminal capacitance	Ct	$V_{R} = 0 V, f = 1 MHz$		50		pF
Temperature coefficient of zener voltage *3	SZ	$I_Z = 1 \text{ mA}$		3.0		mV/°C

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. \*1: The temperature must be controlled 25°C for  $V_Z$  measurement.  $V_Z$  value measured at other temperature must be adjusted to  $V_Z$  (25°C) \*2:  $V_Z$  guaranteed 20 ms after current flow.

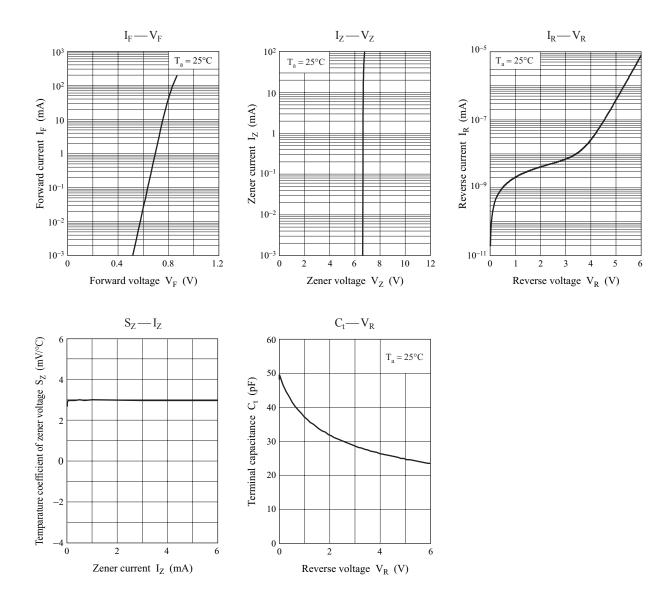
\*3:  $T_j = 25^{\circ}C$  to  $150^{\circ}C$ 



- Code
  SSMini2-F5-B
- Pin Name
- 1. Cathode
- 2. Anode
- Marking Symbol: E2

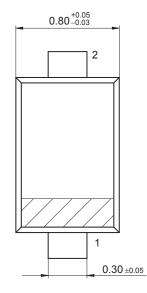
#### DE2S068

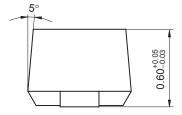
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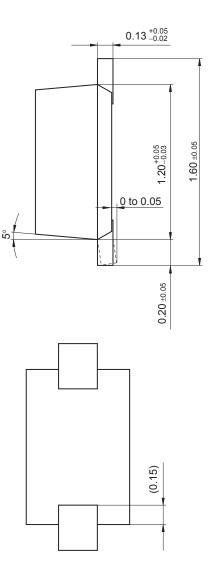


### SSMini2-F5-B

Unit: mm







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